

**GENERAL DESCRIPTION**

This high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

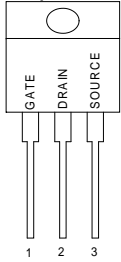
**FEATURES**

- ◆ Robust High Voltage Termination
- ◆ Avalanche Energy Specified
- ◆ Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- ◆ Diode is Characterized for Use in Bridge Circuits
- ◆  $I_{DSS}$  and  $V_{DS(on)}$  Specified at Elevated Temperature
- ◆ Isolated Mounting Hole Reduces Mounting Hardware

**PIN CONFIGURATION**

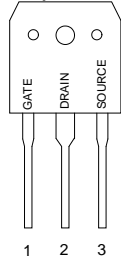
TO-220/TO-220F

Top View

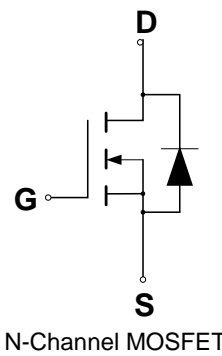


TO-3P/T-O247

Top View



**SYMBOL**



**ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit	
Drain to Current – Continuous	$I_{D(1)}$	28	A	
– Pulsed	$I_{DM}$	84		
Gate-to-Source Voltage – Continue	$V_{GS}$	±20	V	
Total Power Dissipation – TO220	$P_D$	245	W	
– TO220FP		42		
–TO3P		255		
–TO247		227		
Derate above 25°C – TO220		1.96		W/°C
– TO220FP		0.33		
–TO3P	2.04			
–TO247	1.82			
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C	
Single Pulse Drain-to-Source Avalanche Energy – $T_J = 25^\circ\text{C}$ ( $V_{DD} = 100\text{V}, V_{GS} = 10\text{V}, I_L = 8\text{A}, L = 10\text{mH}, R_G = 25$ )	$E_{AS}$	320	mJ	
Thermal Resistance – Junction to Case -TO220	$J_C$	0.51	°C/W	
– Junction to Case -TO220FP		3		
– Junction to Case -TO3P		0.49		
– Junction to Case -TO247		0.55		
– Junction to Ambient -TO220, TO220FP		$J_A$		62.5
– Junction to Ambient -TO3P, TO247	40			
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	$T_L$	260	°C	

(1) Drain current limited by maximum junction temperature

**ORDERING INFORMATION**

Part Number	TOP MARK	Part Number	Packing Mthod	Note
GP28S50XN220 (Note1)	GP28S50X	TO-220	Tube	
GP28S50XN220FP (Notte1)	GP28S50X	TO-220FP	Tube	
GP28S50XN3P (Notte2)	GP28S50X	TO-3P	Tube	
GP28S50XN247 (Notte2)	GP28S50X	TO-247	Tube	
GP28S50GN220 (Note2)	GP28S50G	TO-220	Tube	
GP28S50GN220FP (Notte2)	GP28S50G	TO-220FP	Tube	
GP28S50GN3P (Notte2)	GP28S50G	TO-3P	Tube	
GP28S50GN247 (Notte2)	GP28S50G	TO-247	Tube	

**Note1:** X : Suffix for Halogen Free Product,

**Note2:** G : Suffix for PB Free Product,

**ELECTRICAL CHARACTERISTICS**

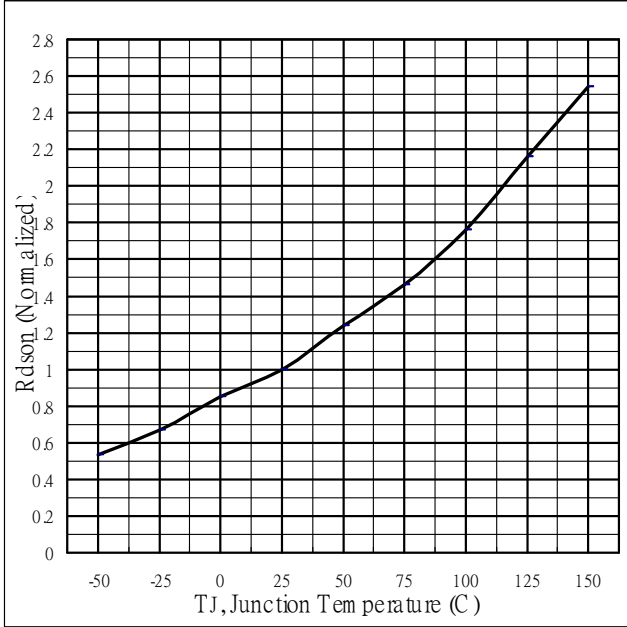
Unless otherwise specified,  $T_J = 25^\circ\text{C}$ .

Characteristic	Symbol	GP28S50			Units
		Min	Typ	Max	
Drain-Source Breakdown Voltage ( $V_{GS} = 0\text{ V}$ , $I_D = 250\ \mu\text{A}$ )	$V_{(BR)DSS}$	500			V
Drain-Source Leakage Current ( $V_{DS} = 500\text{ V}$ , $V_{GS} = 0\text{ V}$ )	$I_{DSS}$			1	$\mu\text{A}$
Gate-Source Leakage Current-Forward ( $V_{gsf} = 20\text{ V}$ , $V_{DS} = 0\text{ V}$ )	$I_{GSSF}$			100	nA
Gate-Source Leakage Current-Reverse ( $V_{gsr} = -20\text{ V}$ , $V_{DS} = 0\text{ V}$ )	$I_{GSSR}$			100	nA
Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 250\ \mu\text{A}$ )	$V_{GS(th)}$	2	3	4	V
Static Drain-Source On-Resistance ( $V_{GS} = 10\text{ V}$ , $I_D = 15\text{A}$ ) *	$R_{DS(on)}$			125	m
Gate resistance ( $f=1\text{MHz}$ , open drain)	$R_G$		2.7		
Input Capacitance	$(V_{DS} = 25\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1.0\text{ MHz}$ )	$C_{iss}$	1517.7		pF
Output Capacitance		$C_{oss}$	1766.7		pF
Reverse Transfer Capacitance		$C_{rss}$	50.3		pF
Turn-On Delay Time	$(V_{DD} = 250\text{ V}$ , $I_D = \text{A}$ , $R_G = 25\ \Omega$ ) *	$t_{d(on)}$	34.9		ns
Rise Time		$t_r$	104.5		ns
Turn-Off Delay Time		$t_{d(off)}$	97.4		ns
Fall Time		$t_f$	65.0		ns
Total Gate Charge	$(V_{DS} = 400\text{ V}$ , $I_D = 20\text{ A}$ , $V_{GS} = 10\text{ V}$ )*	$Q_g$	40.7		nC
Gate-Source Charge		$Q_{gs}$	10.1		nC
Gate-Drain Charge		$Q_{gd}$	18.7		nC
SOURCE-DRAIN DIODE CHARACTERISTICS					
Forward On-Voltage(1)	$(I_S = 20\text{ A}$ , $d_I/d_t = 100\text{A}/\mu\text{s}$ )	$V_{SD}$		1.5	V
Forward Turn-On Time		$t_{on}$		**	ns
Reverse Recovery Time		$t_{rr}$		741	ns

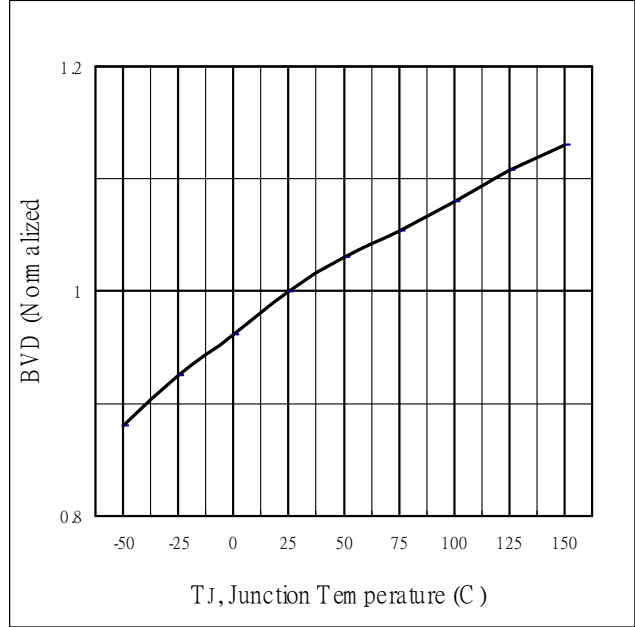
\* Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$

\*\* Negligible, Dominated by circuit inductance

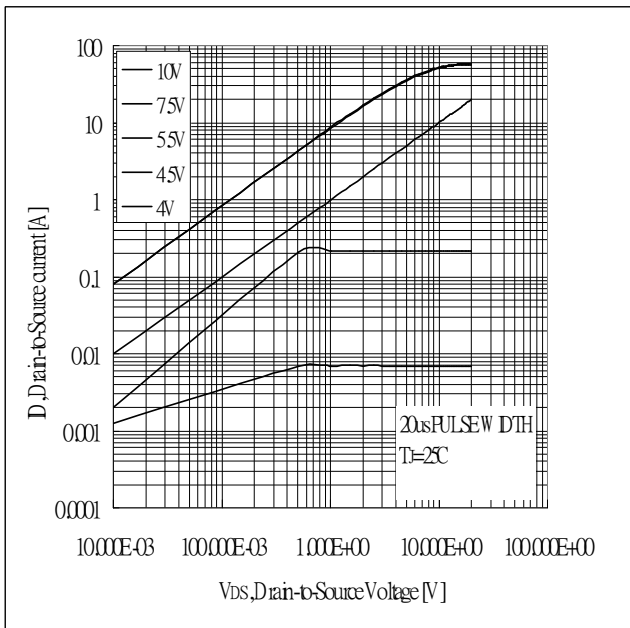
**TYPICAL ELECTRICAL CHARACTERISTICS**



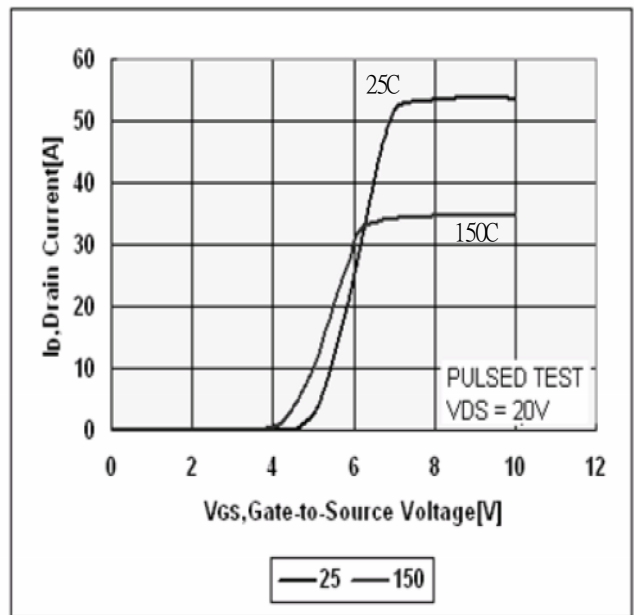
**Fig 1. On-Resistance Variation with vs. Temperature**



**Fig.2 Breakdown Voltage Variation vs. Temperature**



**Fig 3. Typical Output Characteristics**



**Fig 4. Typical Transfer Characteristics**

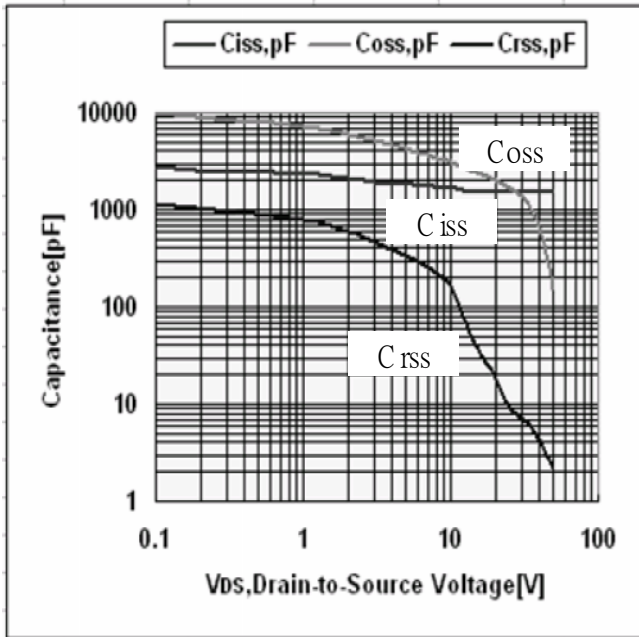


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

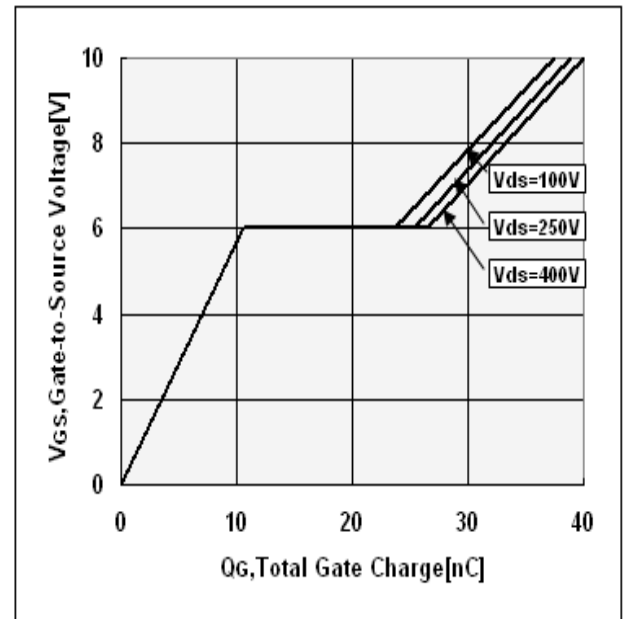
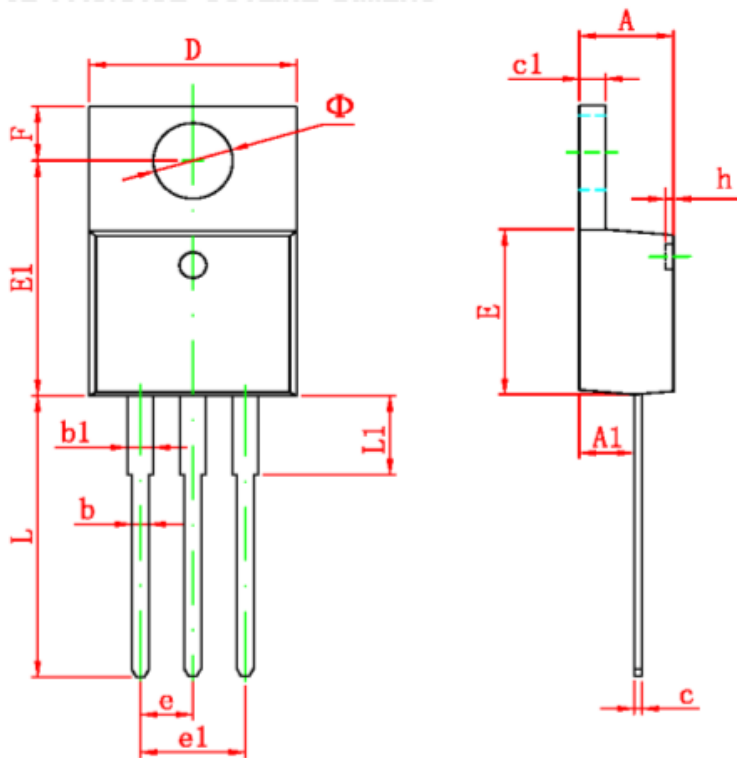


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

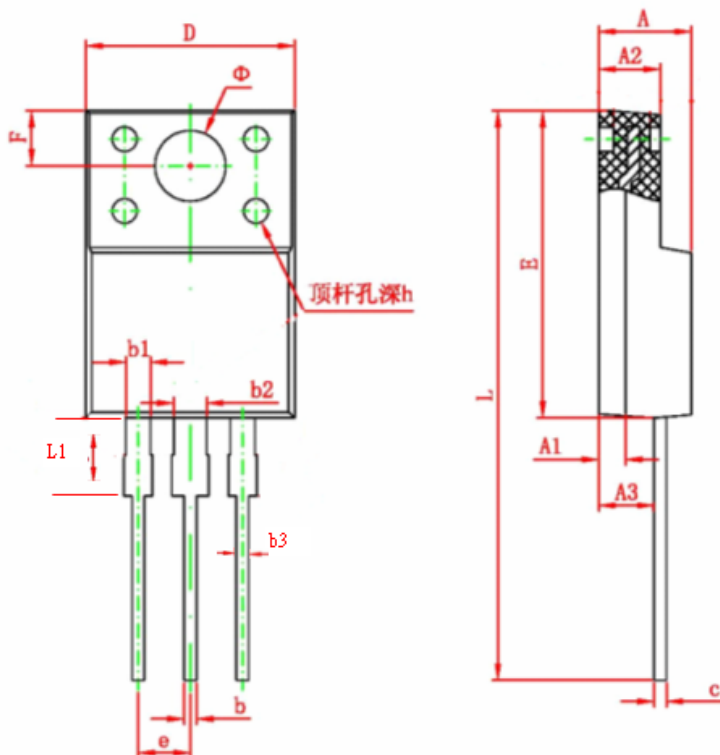
PACKAGE DIMENSION

TO-220



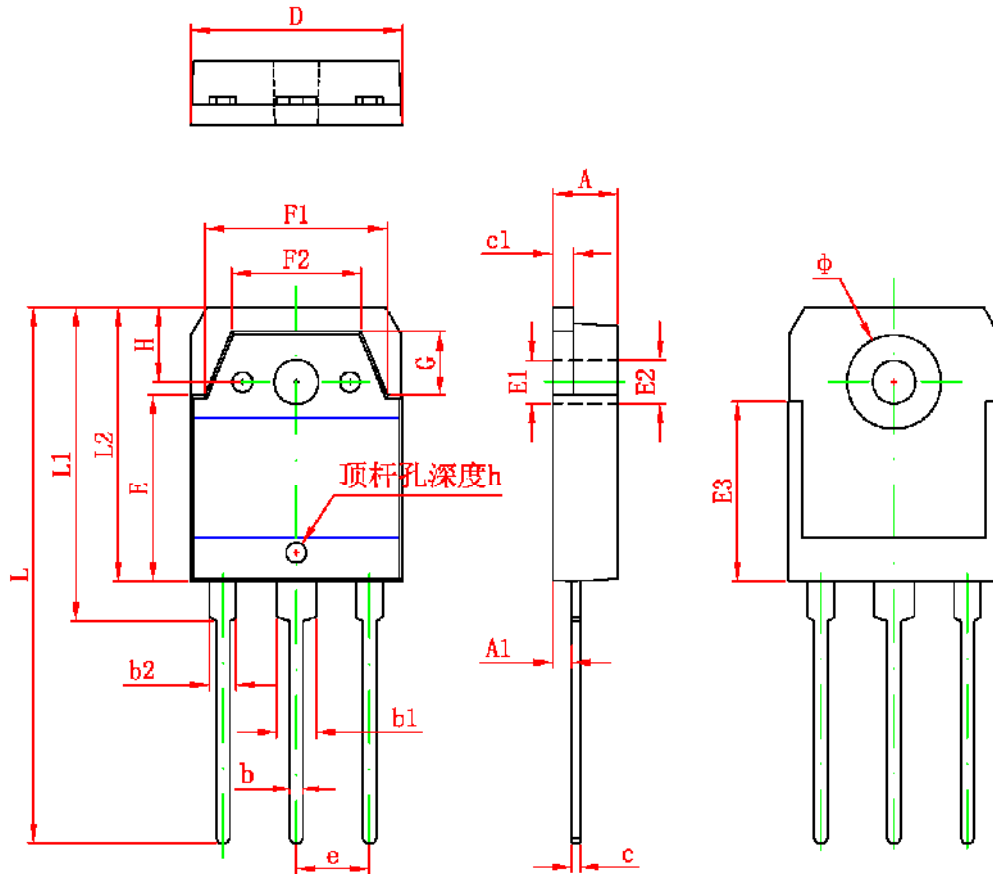
Symbol	Dimensions In Millimeters	
	Min.	Max
A	4.40	4.80
A1	2.10	2.84
b	0.71	0.91
b1	1.17	1.37
c	0.30	0.60
c1	1.17	1.47
D	9.40	10.60
E	8.40	9.60
e	2.54 TYP.	
e1	4.90	5.60
F	3.00 REF.	
$\Phi$	3.50 REF.	
h	0.00	0.30
L	12.50	14.00
L1	3.50	4.00

TO-220FP



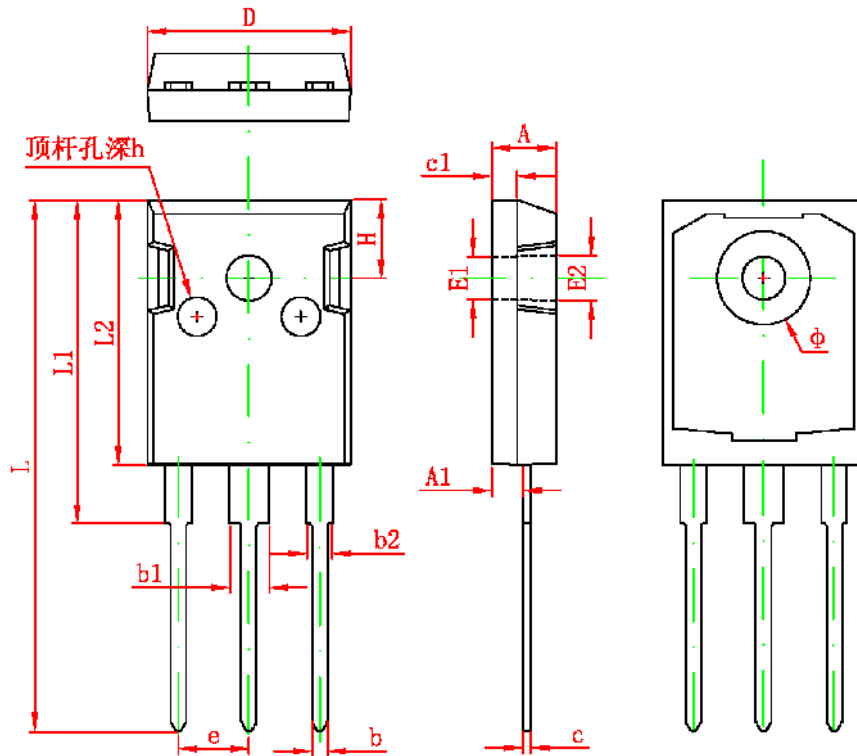
Symbol	Dimensions In Millimeters	
	Min.	Max
A	3.80	4.70
A1	1.3 REF.	
A2	2.20	3.20
A3	2.10	3.20
b	0.30	0.95
b1	1.00	1.75
b2	1.00	1.75
b3	0.50	0.80
c	0.30	0.90
D	9.90	10.40
E	14.60	16.20
e	2.54 TYP.	
F	3.00 REF.	
$\Phi$	3.50 REF.	
h	0.00	0.30
L	28.00	30.00
L1	3.20	3.55

TO-3P



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.600	5.000	0.181	0.197
A1	1.200	1.600	0.047	0.063
b	0.800	1.200	0.031	0.047
b1	2.800	3.200	0.110	0.126
b2	1.800	2.200	0.071	0.087
c	0.500	0.700	0.020	0.028
c1	1.450	1.850	0.057	0.065
D	15.450	15.850	0.606	0.622
E	13.700	14.100	0.539	0.555
E1	3.200 REF		0.126 REF	
E2	3.300 REF		0.130 REF	
E3	13.450 REF		0.530 REF	
F1	13.400	13.800	0.528	0.543
F2	9.400	9.800	0.370	0.386
L	39.900	40.300	1.571	1.687
L1	23.200	23.600	0.913	0.929
L2	20.300	20.600	0.799	0.811
phi	6.900	7.100	0.272	0.280
G	5.150	5.550	0.203	0.219
e	5.450 TYP		0.215 TYP	
H	5.000 REF		0.197 REF	
h	0.000	0.300	0.000	0.012

**TO-247**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.850	5.150	0.191	0.200
A1	2.200	2.600	0.087	0.102
b	1.000	1.400	0.039	0.055
b1	2.800	3.200	0.110	0.126
b2	1.800	2.200	0.071	0.087
c	0.500	0.700	0.020	0.028
c1	1.900	2.100	0.075	0.083
D	15.450	15.750	0.608	0.620
E1	3.500 REF		0.138 REF	
E2	3.600 REF		0.142 REF	
L	40.900	41.300	1.610	1.626
L1	24.800	25.100	0.976	0.988
L2	20.300	20.600	0.799	0.811
$\phi$	7.100	7.300	0.280	0.287
e	5.450 TYP		0.215 TYP	
H	5.980 REF		0.235 REF	
h	0.000	0.300	0.000	0.012

## IMPORTANT NOTICE

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